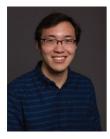
Recognizes, on an annual basis, the most significant contribution by a published paper to the field of interest of the MTT-S. The Microwave Prize is the Society's oldest Award.

S. Zhang, R. Lu, H. Zhou, S. Link, Y. Yang, Z Li, K. Huang, X. Ou, and S. Gong, for their paper "Surface Acoustic Wave Devices using Lithium Niobate on Silicon Carbide", IEEE Transactions on Microwave Theory and Techniques, vol. 68, no. 9, pp. 3653-3666, September 2020.



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No photo or bio available at time of publication.

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